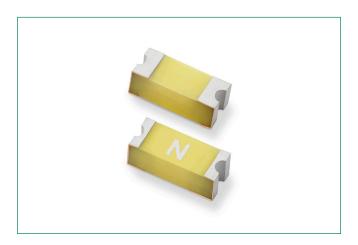
## **Surface Mount Fuses** Thin Film Fuse > 422 > 2410 Fast Acting





#### **Description**

The 422 Series fuse is a 250 V rated Wire-in-Air Surface Mount Fuse, designed specifically to provide circuit protection to space constrained application. The wire-in-air design of the 422 Series results in a relatively high I2t in a 2410 size.

#### **Features**

- Operating Temperature from-55°C to 125° C
- 100% Lead-free, Halogen-Free and RoHS compliant
- Fast Acting
- Recognized to UL/CSA/NMX 248-1 and UL/CSA/NMX 248-14
- Conforms to EN 60127-1 and EN 60127-7
- Conforms to J60127-1 and J60127-7

#### **Agency Approvals**

Agency	Agency File Number	Ampere Range
c <b>Fl</b> °us	E10480	0.75 A to 5 A
<b>A</b>	J50501694	0.75 A to 5 A
	JD60156347	0.75 A to 5 A

#### **Benefits**

 Avoids nuisance opening due to high inrush and surge current inherent in the system

Suitable for harsh environments

# **Electrical Characteristics**

**Electrical Specifications** 

% of Ampere Rating	Ampere Rating	Opening Time at 25°C
100%	0.75 A to 5 A	4 Hours, Minimum
200%	0.75 A to 5 A	5 Seconds, Maximum

#### **Applications**

- Industrial Equipment
- Backlight Inverter
- Power Supply
- Telecom

- Server
- Networking
- Gaming System
- White goods

#### **Additional Information**







Resources

Accessories

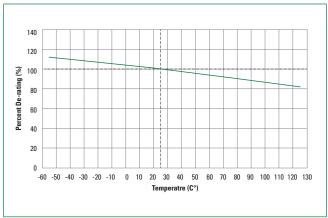
Samples

Ampere	Amp	Max	Interrupting	Nominal Resistance	Nominal	Age	ncy Appro	vals
Rating (A)	Code	(V)		(Ohms) <sup>2</sup>	Melting I <sup>2</sup> t (A <sup>2</sup> sec) <sup>3</sup>	c <b>FN</b> °us		$\triangle$
0.750	.750	250	300A@32VDC	0.137	0.282	Х	Х	Х
1.00	001.	250	100A@125VDC	0.0994	0.611	Х	Х	Х
1.25	1.25	250	50A@250VAC 50A@250VDC	0.0734	1.09	Х	Х	Х
1.50	01.5	250	00/10200120	0.0589	1.62	Х	Х	Х
2.00	002.	250	10,000A@86VDC	0.0453	2.85	Х	Х	Х
2.50	02.5	125		0.0278	1.29	Х	Х	Х
3.00	003.	125	300A@32VDC	0.0223	2.09	Х	Х	Х
3.15	3.15	125	100A@125VDC	0.0213	2.40	X	Х	Х
3.50	03.5	125	100A@125VDC	0.0192	2.82	Х		Х
4.00	004.	125	50A@125VAC	0.0168	3.60	X	Х	Х
5.00	005.	125		0.0137	5.90	Х	Х	Х

- 1. AC Interrupting Rating tested at rated voltage with unity power factor. DC Interrupting Rating tested with time constant <0.8 ms for 32 VDC, <2.2 ms for 86 VDC, <0.22 ms for 125 VDC, and <0.1 ms for 250 VDC.
- 2. Nominal Resistance measured with <10% rated current. 3. Nominal Melting I2t measured at 1msec. opening time.

# Surface Mount Fuses Thin Film Fuse > 422 > 2410 Fast Acting

### **Temperature Re-rating Curve**



#### Notes

 ${\bf 1}.$  Re-rating depicted in this curve is in addition to the standard re-rating of 25% for continuous operation.

#### Example:

For continuous operation at  $85^{\circ}$ C, the fuse should be rerated as follows:  $I = (0.75)(0.90)I_{N} = (0.675)I_{N}$ 

#### **Pulse Cycle Withstand Capability**

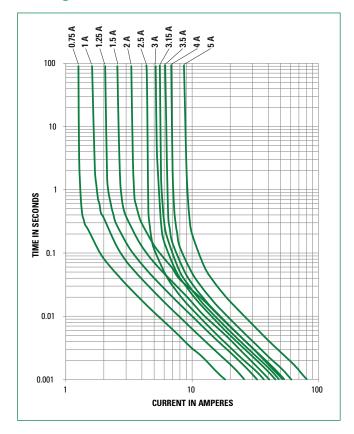
No. of Pulses to withstand	Ratio of Pulse I <sup>2</sup> t to Nominal I <sup>2</sup> t
100,000	Pulse $I^2t = 18\%$ of Nominal Melting $I^2t$
10,000	Pulse $I^2t = 29\%$ of Nominal Melting $I^2t$
1,000	Pulse $I^2t = 38\%$ of Nominal Melting $I^2t$
100	Pulse $I^2t = 48\%$ of Nominal Melting $I^2t$

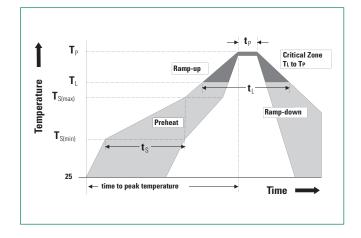
#### Note

#### **Soldering Perameters**

Reflow Condition		Pb – Free assembly	
Pre Heat	-Temperature Min (T <sub>s(min)</sub> )	150 °C	
	-Temperature Max (T <sub>s(max)</sub> )	200 °C	
	-Time (Min to Max) (t <sub>s</sub> )	60-180 secs	
Average ram	5 °C/second max.		
T <sub>S(max)</sub> to T <sub>L</sub> - Ramp-up Rate		5 °C/second max.	
Reflow	-Temperature (T <sub>L</sub> ) (Liquidus)	217 °C	
	-Temperature (t <sub>L</sub> )	60-150 secs	
Peak Temperature (T <sub>p</sub> )		260+0/-5 °C	
Time within 5 °C of actual peak Temperature (t <sub>p</sub> )		10-30 seconds	
Ramp-down Rate		6°C/second max.	
Time 25 °C to peak Temperature (T <sub>p</sub> )		8 minutes max.	
Do not exceed		260 °C	
		<u> </u>	

#### **Average Time Current Curves**







**Wave Soldering Parameters** 

260°C Peak Temperature,

10 seconds max.

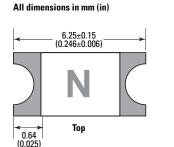
<sup>\*</sup> Being tested

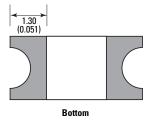
# Surface Mount Fuses Thin Film Fuse > 422 > 2410 Fast Acting

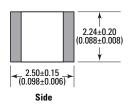
#### **Product Characteristics**

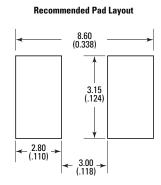
Materials	Body: Epoxy Resin Terminations: Cu/Ni/Sn (100% Pb-free)
Product Marking	Body: Current Rating
Insulation Resistance	IEC 60127-4 (0.1 MOhm Min.)
High Temperature Storage	MIL-STD-202, Method 108
Thermal Shock Test	JESD22 Method A104C
Biased Humidity	MIL-STD-202, Method 103, 85 °C/85% RH with 10% operating power for 1000 hrs
Operational Life	MIL-STD-202, Method 108, Test Condition D
Resistance to Solvents	MIL-STD-202, Method 215
Mechanical Shock	MIL-STD-202, Method 213, Test Condition C
High Frequency Vibration	MIL-STD-202, Method 204
Resistance to Soldering Heat	MIL-STD-202, Method 210 (Test K modified)
Solderability	JESD22-B102E Method 1
Moisture Resistance	MIL-STD-202 Method 106
Moisture Sensitivity Level 1	IPC/JEDEC J-STD-020D Level 1
Terminal Strength	AEC Q200 -006
Board Bend/Flex	AEC Q200-005

#### **Dimensions (in mm)**

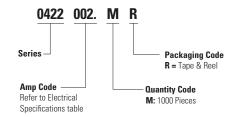








#### **Part Numbering System**



#### **Packaging**

Packaging Option	Packaging Specification	Quantity	Quantity & Packaging Code
Tape and Reel	EIA-481	1000	MR

#### **Part Marking System**

Amp Code	Marking Code
.750	G
001.	н
1.25	J
01.5	К
002.	N
02.5	0
003.	P
3.15	В
03.5	С
004.	s
005.	Т

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